







SN75ALS193 SLLS008E - JUNE 1986 - REVISED OCTOBER 2023

SN75ALS193 Quadruple Differential Line Receiver

1 Features

- Meets or exceeds ANSI standard EIA/TIA-422-B and EIA/TIA-423-A and ITU recommendations V.10 and V.11
- Designed for multipoint bus transmission on long bus lines in noisy environments
- 3-state outputs
- Common-mode input voltage range: -7 V to 7 V
- Input sensitivity: ±200 mV
- Input hysteresis: 120-mV typical
- High input impedance: 12-kΩ minimum
- Operates from single 5-V supply
- Low supply current requirement 35-mA maximum
- Improved speed and power version of the AM26LS32A

2 Applications

- Motor drives
- Factory automation and control

3 Description

The SN75ALS193 is a monolithic quadruple line receiver with 3-state outputs designed using advanced low-power Schottky technology. This technology provides combined improvements in bar design, tooling production, and wafer fabrication. This, in turn, provides significantly lower power requirements and permits much higher data

throughput than other designs. This device meets the specifications of ANSI Standards EIA/TIA-422-B and EIA/TIA-423-A and ITU Recommendations V.10 and V.11. It features 3-state outputs that permit direct connection to a bus-organized system with a fail-safe design that ensures the outputs will always be high if the inputs are open.

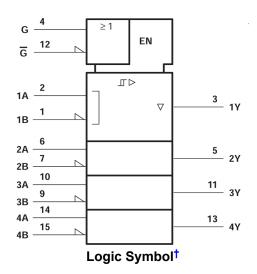
The device is optimized for balanced multipoint bus transmission at rates up to 20 megabits per second. The input features high input impedance, input hysteresis for increased noise immunity, and an input sensitivity of ± 200 mV over a common-mode input voltage range of -7 to 7 V. It also features active-high and active-low enable functions that are common to the four channels. The SN75ALS193 is designed for optimum performance when used with the 'ALS192 quadruple differential line driver.

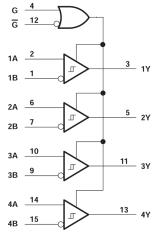
The SN75ALS193 is characterized for operation from 0°C to 70°C.

Package Information

PART NUMBER	PACKAGE ⁽¹⁾	PACKAGE SIZE ⁽²⁾		
SN75ALS193	N (PDIP, 16)	19.3 mm × 9.4 mm		
SINT SALS 193	D (SOIC, 16)	9.9 mm × 6 mm		

- For more information, see Section 10.
- The package size (length × width) is a nominal value and includes pins, where applicable.





Logic Diagram (Positive Logic)

[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.



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4 Pin Configuration and Functions

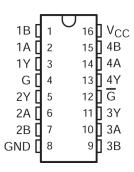


Figure 4-1. D or N Package (Top View)

Table 4-1. Pin Functions

PIN		TYPE(1)	DESCRIPTION			
NAME	NO.	ITPE(''	DESCRIPTION			
1B	1	I	Channel 1 Differential Receiver Inverting Input			
1A	2	I	Channel 1 Differential Receiver Non-Inverting Input			
1Y	3	0	Channel 1 Single Ended Output			
G	4	I	Active High Enable			
2Y	5	0	nel 2 Single Ended Output			
2A	6	I	nnel 2 Differential Receiver Non-Inverting Input			
2B	7	I	Channel 2 Differential Receiver Inverting Input			
GND	8	GND	Device GND			
3B	9	I	Channel 3 Differential Receiver Inverting Input			
3A	10	I	Channel 3 Differential Receiver Non-Inverting Input			
3Y	11	0	Channel 3 Single Ended Output			
G	12	I	Active Low Enable			
4Y	13	0	Channel 4 Single Ended Output			
4A	14	I	Channel 4 Differential Receiver Non-Inverting Input			
4B	15	I	Channel 4 Differential Receiver Inverting Input			
V _{CC}	16	PWR	Device VCC (4.75V to 5.25V)			

⁽¹⁾ Signal Types: I = Input, O = Output, I/O = Input or Output.



5 Specifications

5.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)(1)

		MIN	MAX	UNIT
V _{CC}	Supply voltage, see ⁽²⁾		7	V
V _I	Input voltage, A or B		±15	V
V _{ID}	Differential input voltage, see (3)		±15	V
VI	Enable input voltage		7	V
I _{OL}	Low-level output current		50	mA
	Continuous total dissipation	See Dissipation Rating	table	
T _A	Operating free-air temperature range	0	70	°C
	Lead temperature 1,6 mm (1/16 inch) from case for 60 seconds		300	°C
T _{stg}	Storage temperature range	-65	150	°C

⁽¹⁾ Stresses beyond those listed under absolute maximum ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under recommended operating conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

5.2 Dissipation Rating

PACKAGE	T _A ≤ 25°C POWER RATING	DERATING FACTOR ABOVE T _A = 25°C	T _A = 70°C POWER RATING	
N	1150 mW	9.2 mW/°C	736 mW	

5.3 Recommended Operating Conditions

-	MIN	NOM	MAX	UNIT
Supply voltage, V _{CC}	4.75	5	5.25	V
Common-mode input voltage, V _{IC}			±7	V
Differential input voltage, V _{ID}			±12	V
High-level input voltage, V _{IH}	2			V
Low-level input voltage, V _{IL}			0.8	V
High-level output current, I _{OH}			-400	μA
Low-level output current, I _{OL}			16	mA
Operating free-air temperature, T _A	0	70		°C

5.4 Thermal Information

• • • • • • • • • • • • • • • • • • • •				
		SN75/		
THERMAL METRIC ⁽¹⁾		N (PDIP)	D (SOIC)	UNIT
		16 Pins	16 Pins	
R _{θJA}	Junction-to-ambient thermal resistance	60.6	84.6	°C/W
R _{θJC(top)}	Junction-to-case (top) thermal resistance	48.1	43.5	°C/W
R _{θJB}	Junction-to-board thermal resistance	40.6	43.2	°C/W
Ψ JT	Junction-to-top characterization parameter	27.5	10.4	°C/W
Ψ ЈВ	Junction-to-board characterization parameter	40.3	42.8	°C/W

For more information about traditional and new thermal metrics, see the Semiconductor and IC package thermal metrics application report.

Product Folder Links: SN75ALS193

All voltage values, except differential input voltage, are with respect to network ground terminal.

⁽³⁾ Differential-input voltage is measured at the noninverting input with respect to the corresponding inverting input.



5.5 Electrical Characteristics

over recommended range of common-mode input voltage, supply voltage, and operating free-air temperature (unless otherwise noted)

	PARAMETER	TEST C	ONDITIONS ⁽¹⁾	MIN	TYP ⁽²⁾	MAX	UNIT
V _{IT+}	Positive-going input threshold voltage					200	mV
V _{IT-}	Negative-going input threshold voltage			-200 ⁽³⁾			mV
V _{hys}	Hysteresis voltage (V _{IT+} -V _{IT-})				120		mV
V _{IK}	Enable-input clamp voltage	V _{CC} = MIN,	I _I = -18 mA			-1.5	V
V _{OH}	High-level output voltage	V _{CC} = MIN, I _{OH} = – 400 μA,	V _{ID} = 200 mV, See Figure 1	2.5	1.6		V
		$V_{CC} = MIN, V_{ID} = -$ It voltage I_{OI}				0.45	
V _{OL}	Low-level output voltage	200 mV, See Figure 1	I _{OL} = 16 mA			0.5	V
	High-impedance-state output current	\/ - MAY	V _O = 2.4 V			20	
I _{OZ}	nigh-impedance-state output current	V _{CC} = MAX	V _O = 0.4 V			-20	μA
	Line input current	Other input at 0, See	V _{CC} = MIN, V _I = 15 V		0.7	1.2	mA
l I	Line input current	(4)	$V_{CC} = MIN, V_I = -15 V$		-1.0	-1.7	ША
	High level enable input current	\/ - MAY	V _{IH} = 2.7 V			20	^
I _{IH}	High-level enable-input current	V _{CC} = MAX	V _{IH} = MAX			100	μA
I _{IL}	Low-level enable-input current	V _{CC} = MAX,	V _{IL} = 0.4 V			-100	μA
	Input resistance			12	18		kΩ
Ios	Short-circuit output current	$V_{CC} = MAX, V_O = 0,$	V _{ID} = 3 V, See ⁽⁵⁾	-15	-78	-130	mA
I _{CC}	Supply current	V _{CC} = MAX,	Outputs disabled		22	35	mA

- (1) For conditions shown as MIN or MAX, use the appropriate values specified under recommended operating conditions.
- (2) All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.
- (3) The algebraic convention, in which the less positive limit is designated minimum, is used in this data sheet for threshold voltage levels only.
- (4) Refer to ANSI Standard EIA/TIA-422-B and EIA/TIA-423-A for exact conditions.
- (5) Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second.

5.6 Switching Characteristics

 V_{CC} = 5 V, T_A = 25°C

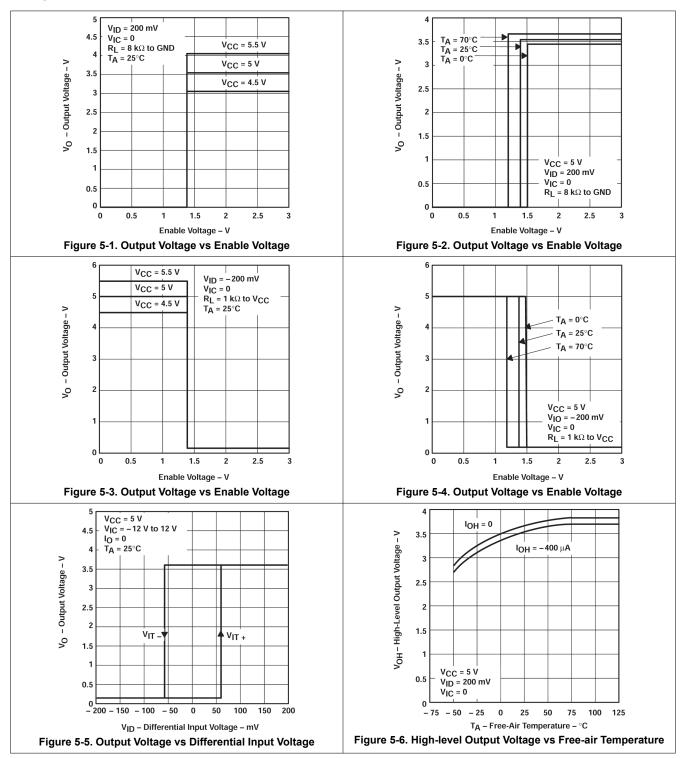
	PARAMETER	TEST (CONDITIONS	MIN	TYP	MAX	UNIT
t _{PLH}	Propagation delay time, low-to-high-level output	V _{ID} = -2.5 \	√ to 2.5 V		15	22	
t _{PHL}	Propagation delay time, high-to-low-level output	C _L = 15 pF	See Figure 6-1		15	22	
4	Output enable time to high level	C =15 pE	See Figure 6-2		13	25	no
^L PZH	t _{PZH} Output enable time to high level	CL = 15 PF	See Figure 6-2		11	25	ns
	Output disable time from high level	$C_1 = 5 pF$	See Figure 6-2		13	25	
t _{PHZ}	Output disable time from high level	CL = 5 PF	See Figure 0-2		15	22	

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5.7 Typical Characteristics





5.7 Typical Characteristics (continued)

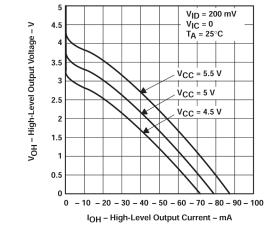


Figure 5-7. High-level Output Voltage vs High-level Output
Current

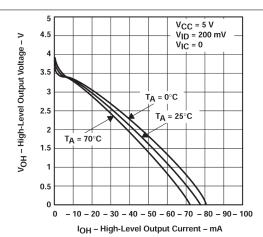


Figure 5-8. High-level Output Voltage vs High-level Output
Current

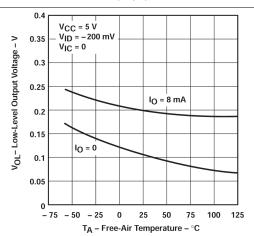


Figure 5-9. Low-level Output Voltage vs Free-air Temperature

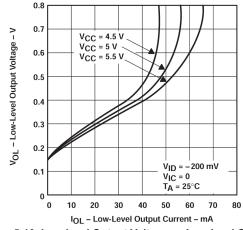


Figure 5-10. Low-level Output Voltage vs Low-level Output Current

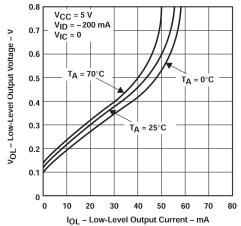


Figure 5-11. Low-level Output Voltage vs Low-level Output Current

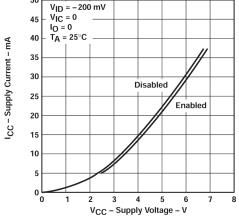


Figure 5-12. Supply Current vs Supply Voltage



5.7 Typical Characteristics (continued)

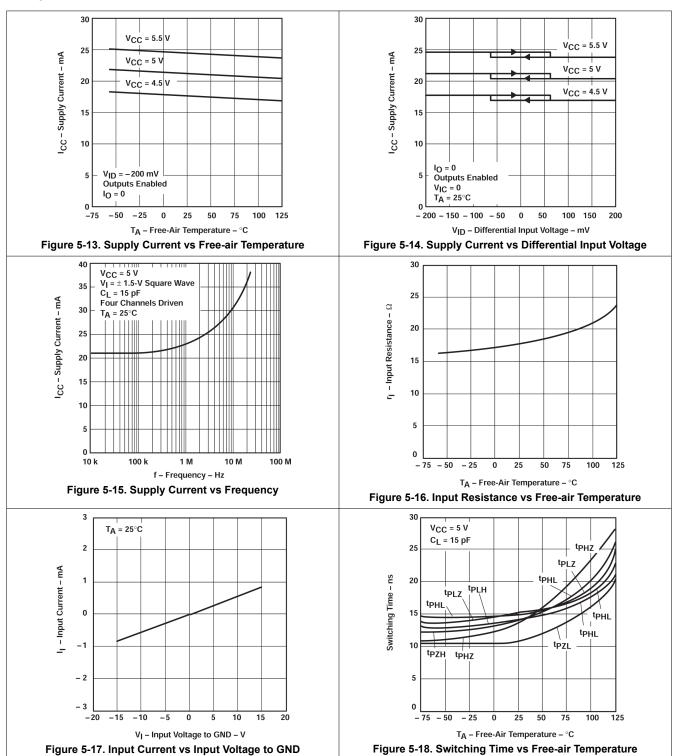
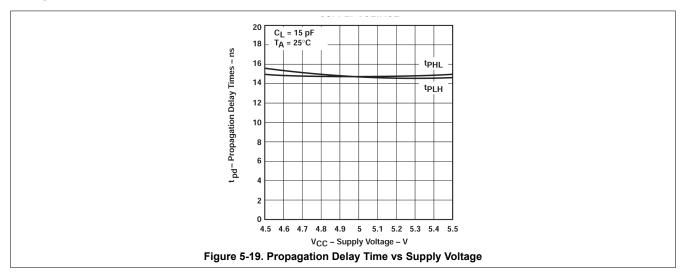


Figure 5-17. Input Current vs Input Voltage to GND



5.7 Typical Characteristics (continued)





6 Parameter Measurement Information

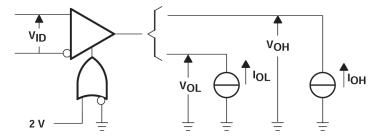
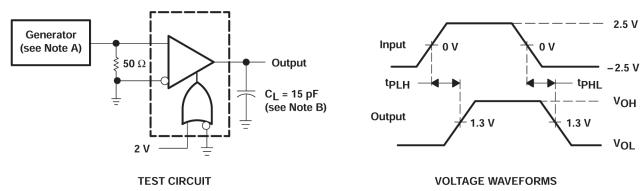


Figure 6-1. V_{OH}, V_{OL}



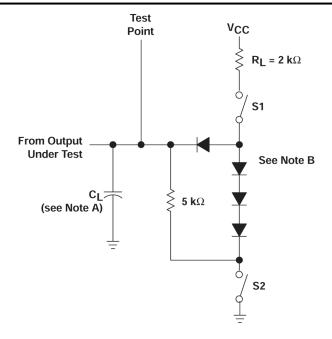
- A. The input pulse is supplied by a generator having the following characteristics: PRR \leq 1 MHz, duty cycle \leq 50%, Z_O = 50 Ω , $t_r \leq$ 6 ns. $t_f \leq$ 6 ns.
- B. C_L includes probe and jig capacitance.

Figure 6-2. Test Circuit and Voltage Waveforms

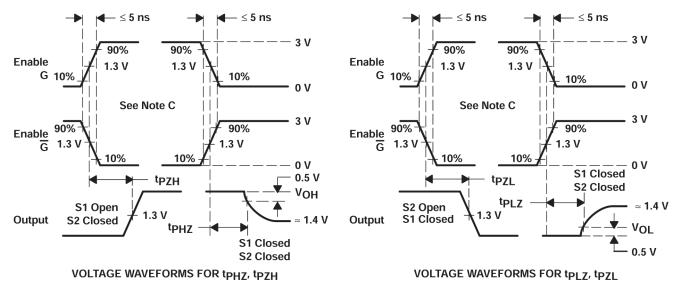
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LOAD CIRCUIT



- A. C_L includes probe and jig capacitance.
- B. All diodes are 1N3064 or equivalent.
- C. Enable G is tested with \overline{G} high; \overline{G} is tested with G low.

Figure 6-3. Load Circuit and Voltage Waveforms

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7 Detailed Description

7.1 Device Functional Modes

Table 7-1. Function Table (Each Receiver)

DIFFERENTIAL INPUTS A – B ⁽¹⁾	EN	OUTPUT Y	
DIFFERENTIAL INFOTS A - B	G	G	OUTFULL
V _{ID} ≥ 0.2 V	Н	X	Н
V _{ID} ≥ 0.2 V	X	L	Н
-0.2 V _{ID} < V _{ID} < 0.2 V	Н	X	?
	X	L	?
V _{ID} ≤ −0.2 V	Н	X	L
V _{ID} = -0.2 V	X	L	L
X	L	Н	Z
Onen	Н	X	Н
Open	X	L	Н

(1) H = high level, L = low level, X = irrelevant, ? = indeterminate, Z = high impedance (off)

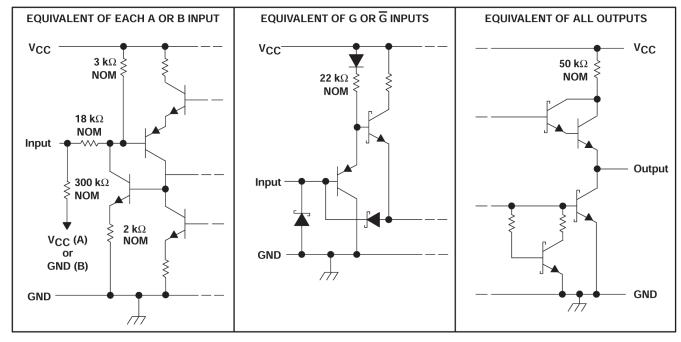


Figure 7-1. Schematics of Inputs and Outputs

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8 Device and Documentation Support

TI offers an extensive line of development tools. Tools and software to evaluate the performance of the device, generate code, and develop solutions are listed below.

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8.4 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

8.5 Glossary

TI Glossary

This glossary lists and explains terms, acronyms, and definitions.

9 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

Changes from Revision D (May 1995) to Revision E (October 2023)

Page

Changed the numbering format for tables, figures, and cross-references throughout the document......

10 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

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PACKAGING INFORMATION

Orderable part number	Status	Material type	Package Pins	Package qty Carrier	RoHS	Lead finish/	MSL rating/	Op temp (°C)	Part marking
	(1)	(2)			(3)	Ball material	Peak reflow		(6)
						(4)	(5)		
SN75ALS193D	Obsolete	Production	SOIC (D) 16	-	-	Call TI	Call TI	0 to 70	75ALS193
SN75ALS193DR	Active	Production	SOIC (D) 16	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	75ALS193
SN75ALS193DR.A	Active	Production	SOIC (D) 16	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	75ALS193
SN75ALS193DRG4	Active	Production	SOIC (D) 16	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	75ALS193
SN75ALS193DRG4.A	Active	Production	SOIC (D) 16	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	75ALS193
SN75ALS193N	Active	Production	PDIP (N) 16	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	(SN75ALS193N, SN7A LS193N)
SN75ALS193N.A	Active	Production	PDIP (N) 16	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	(SN75ALS193N, SN7A LS193N)
SN75ALS193NE4	Active	Production	PDIP (N) 16	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	(SN75ALS193N, SN7A LS193N)

⁽¹⁾ Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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⁽²⁾ Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

⁽⁴⁾ Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.



PACKAGE OPTION ADDENDUM

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and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

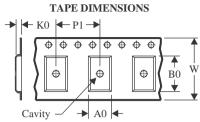
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PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

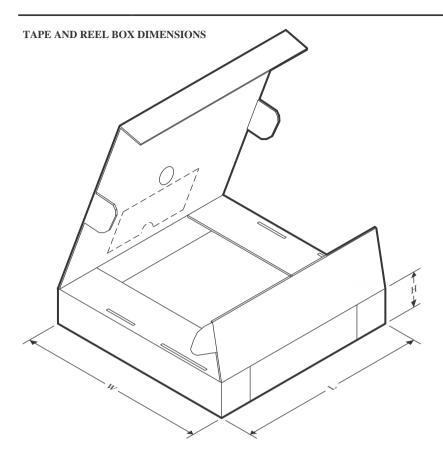


*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN75ALS193DR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
SN75ALS193DRG4	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1

PACKAGE MATERIALS INFORMATION

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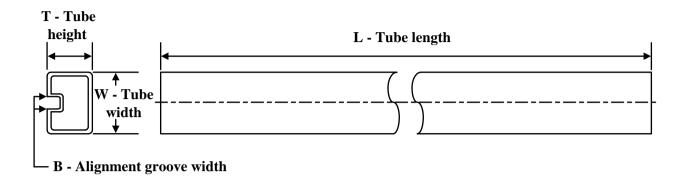
*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN75ALS193DR	SOIC	D	16	2500	340.5	336.1	32.0
SN75ALS193DRG4	SOIC	D	16	2500	353.0	353.0	32.0

PACKAGE MATERIALS INFORMATION

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TUBE



*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
SN75ALS193N	N	PDIP	16	25	506	13.97	11230	4.32
SN75ALS193N.A	N	PDIP	16	25	506	13.97	11230	4.32
SN75ALS193NE4	N	PDIP	16	25	506	13.97	11230	4.32

D (R-PDS0-G16)

PLASTIC SMALL OUTLINE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AC.



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



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